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Vishay Siliconix

# Automotive N-Channel 60 V (D-S) 175 °C MOSFET

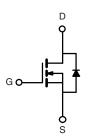
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.014			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.017			
I <sub>D</sub> (A)	40			
Configuration	Single			
Package	TO-252			

### **FEATURES**

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R<sub>q</sub> and UIS tested
- AEC-Q101 qualified d
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>







N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T <sub>C</sub> = 25 °C, unles	ss otherwise noted	l)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	60	V	
Gate-Source Voltage	Gate-Source Voltage		± 20	V	
Continuous Drain Current	T <sub>C</sub> = 25 °C <sup>a</sup>	1	40		
Continuous Drain Current	T <sub>C</sub> = 125 °C	I <sub>D</sub>	29		
Continuous Source Current (Diode Conduc	tion) <sup>a</sup>	Is	40	Α	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	160		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	32		
Single Pulse Avalanche Energy	L = 0.1 11111	E <sub>AS</sub>	51	mJ	
Maximum Power Dissipation b	T <sub>C</sub> = 25 °C	D	75	W	
Maximum i Ower Dissipation -	T <sub>C</sub> = 125 °C	- P <sub>D</sub>	25	VV	
Operating Junction and Storage Temperatu	ire Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>c</sup>	$R_{thJA}$	60	°C/W
Junction-to-Case (Drain)		$R_{thJC}$	2	C/VV

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					I.	I.	
Drain-Source Breakdown Voltage	$V_{DS}$	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	60	-	-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.5	2.0	2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 125 °C	-	-	50	μΑ
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 175 °C	-	-	250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 \text{ V}$	30	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A	-	0.011	0.014	
Drain-Source On-State Resistance <sup>a</sup>	В	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.024	Ω
Diani-Source Oil-State nesistance ~	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.029	52
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 25 °C	-	0.014	0.017	
Forward Transconductance <sup>a</sup>	9fs	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 20 A	-	52	=.	S
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			-	1685	2105	
Output Capacitance	Coss	$V_{GS} = 0 V$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	305	385	pF
Reverse Transfer Capacitance	$C_{rss}$			ı	180	225	
Total Gate Charge <sup>c</sup>	Qg			-	34	51	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	V <sub>GS</sub> = 10 V	$V_{DS} = 30 \text{ V}, I_D = 40 \text{ A}$	1	6	9	nC
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			-	8.5	13	
Gate Resistance	$R_g$	f = 1 MHz		0.8	1.7	3.7	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	8	12	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, \text{ R}_L = 0.75 \Omega$ $I_D \cong 40 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	13	20	ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			ı	22	33	
Fall Time <sup>c</sup>	t <sub>f</sub>	]		1	9	14	
Source-Drain Diode Ratings and Chara	cteristics <sup>b</sup>						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			1	-	160	Α
Forward Voltage	$V_{SD}$	le:	= 20 A, V <sub>GS</sub> = 0	-	0.85	1.2	V

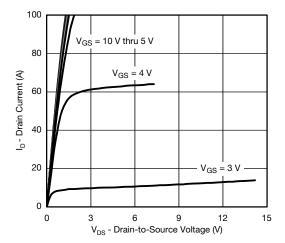
### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

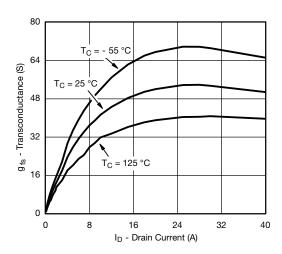
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



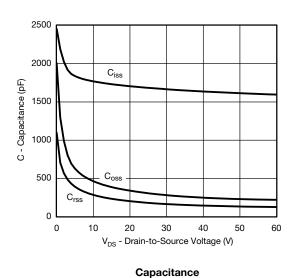
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### **Output Characteristics**

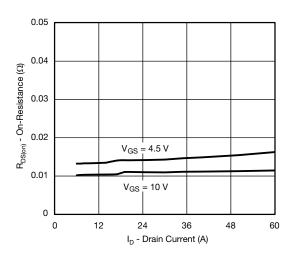


### Transconductance

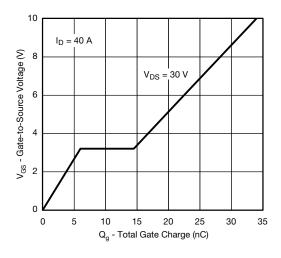


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#### **Transfer Characteristics**

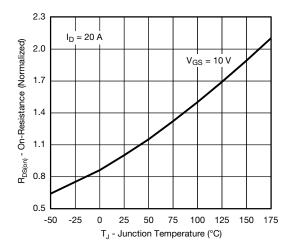


### On-Resistance vs. Drain Current

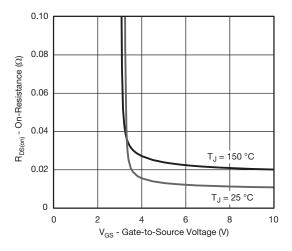




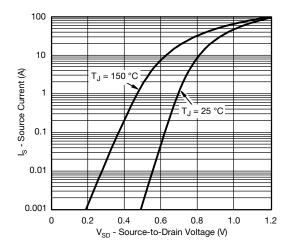
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



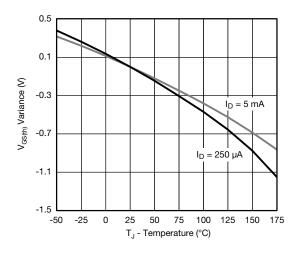
### On-Resistance vs. Junction Temperature



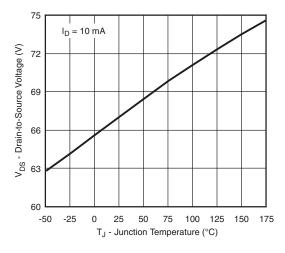
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



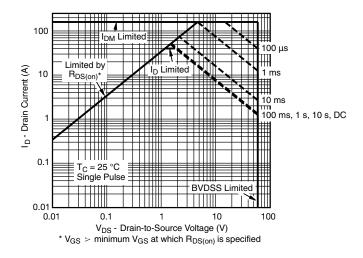
Threshold Voltage



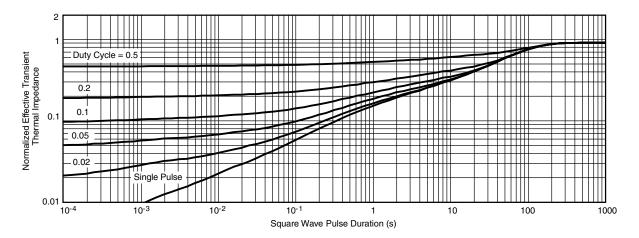
Drain Source Breakdown vs. Junction Temperature



### **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



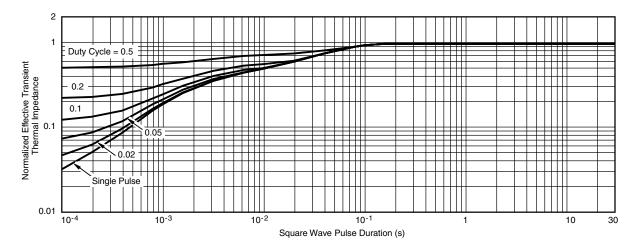
#### **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Ambient



### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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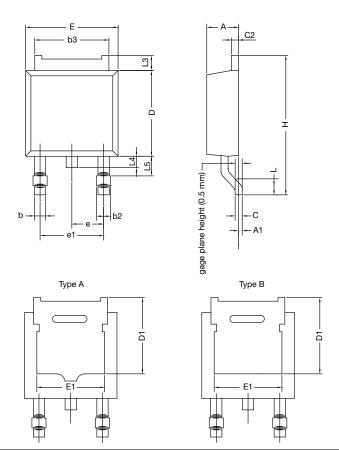
REVISION	HISTORY a	
REVISION	DATE	DESCRIPTION OF CHANGE
С	04-Aug-15	Revised R <sub>g</sub> minimum limit

#### Note

a. As of April 2014



## **TO-252AA Case Outline**



DIM.	MILLIN	METERS	INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	=
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	=
Н	9.40	10.41	0.370	0.410
е	2.28	BSC	0.090	BSC
e1	4.56	BSC	0.180	BSC
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060

ECN: T24-0298-Rev. B, 29-Jul-2024 DWG: 6019

#### Notes

- Dimension L3 is for reference only
- Dimension D1 and E1 on type A and B is the same

Revision: 29-Jul-2024 1 Document Number: 64424



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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